Phase out

Thyristor \ Diode Module

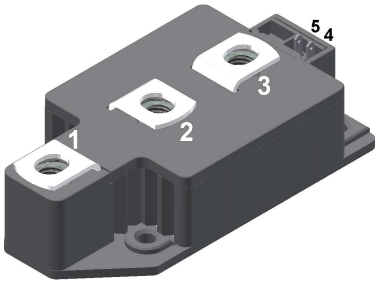
V_{RRM}	=	2x 1400 V
I_{TAV}	=	250 A
V_T	=	1.14 V

PHASE OUT

Phase leg

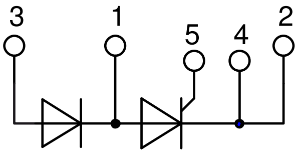
Part number

MCD220-14io1



Backside: isolated

E72873



Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: Y2

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Recommended replacement: MCD310-14io1

IXYS

MCD220-14io1

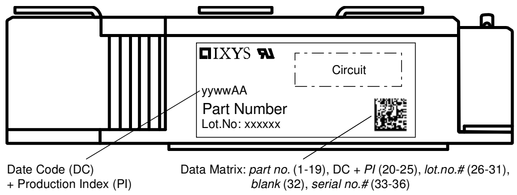
Phase out

Rectifier

Symbol	Definition	Conditions		Ratings min.	typ.	max.	Unit
$V_{RSM/DSM}$	*max. non-repetitive reverse/forward blocking voltage*		T_{VJ} = 25°C			1500	V
$V_{RRM/DRM}$	*max. repetitive reverse/forward blocking voltage*		T_{VJ} = 25°C			1400	V
$I_{R/D}$	*reverse current, drain current*	$V_{R/D}$ = 1400 V	T_{VJ} = 25°C			1	mA
		$V_{R/D}$ = 1400 V	T_{VJ} = 140°C			40	mA
V_T	*forward voltage drop*	I_T = 200 A	T_{VJ} = 25°C			1.24	V
		I_T = 400 A				1.39	V
		I_T = 200 A	T_{VJ} = 125°C			1.14	V
		I_T = 400 A				1.33	V
I_{TAV}	*average forward current*	T_C = 85°C	T_{VJ} = 140°C			250	A
$I_{T(RMS)}$	*RMS forward current*	180° sine				400	A
V_{T0}	*threshold voltage*	*for power loss calculation only*	T_{VJ} = 140°C			0.90	V
r_T	*slope resistance*					1	mΩ
R_{thJC}	*thermal resistance junction to case*					0.14	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.040		K/W
P_{tot}	*total power dissipation*		T_C = 25°C			820	W
I_{TSM}	*max. forward surge current*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			8.50	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			9.18	kA
		t = 10 ms; (50 Hz), sine	T_{VJ} = 140°C			7.23	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			7.81	kA
I^2t	*value for fusing*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			361.3	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			350.6	kA²s
		t = 10 ms; (50 Hz), sine	T_{VJ} = 140°C			261.0	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			253.4	kA²s
C_J	*junction capacitance*	V_R = 400 V f = 1 MHz	T_{VJ} = 25°C		438		pF
P_{GM}	*max. gate power dissipation*	t_P = 30 µs	T_C = 140°C			120	W
		t_P = 500 µs				60	W
P_{GAV}	*average gate power dissipation*					20	W
$(di/dt)_{cr}$	*critical rate of rise of current*	T_{VJ} = 140°C; f = 50 Hz	repetitive, I_T = 750 A			100	A/µs
		t_P = 200 µs; di_G/dt = 1 A/µs;					
		I_G = 1 A; V = ⅔ V_{DRM}	non-repet., I_T = 250 A			500	A/µs
$(dv/dt)_{cr}$	*critical rate of rise of voltage*	V = ⅔ V_{DRM}	T_{VJ} = 140°C			1000	V/µs
		R_{GK} = ∞; method 1 (linear voltage rise)					
V_{GT}	*gate trigger voltage*	V_D = 6 V	T_{VJ} = 25°C			2	V
			T_{VJ} = -40°C			3	V
I_{GT}	*gate trigger current*	V_D = 6 V	T_{VJ} = 25°C			150	mA
			T_{VJ} = -40°C			200	mA
V_{GD}	*gate non-trigger voltage*	V_D = ⅔ V_{DRM}	T_{VJ} = 140°C			0.25	V
I_{GD}	*gate non-trigger current*					10	mA
I_L	*latching current*	t_p = 30 µs	T_{VJ} = 25°C			200	mA
		I_G = 0.45 A; di_G/dt = 0.45 A/µs					
I_H	*holding current*	V_D = 6 V R_{GK} = ∞	T_{VJ} = 25°C			150	mA
t_{gd}	*gate controlled delay time*	V_D = ½ V_{DRM}	T_{VJ} = 25°C			2	µs
		I_G = 1 A; di_G/dt = 1 A/µs					
t_q	*turn-off time*	V_R = 100 V; I_T = 250 A; V = ⅔ V_{DRM}	T_{VJ} = 125 °C		200		µs
		di/dt = 10 A/µs dv/dt = 50 V/µs t_p = 200 µs					

Phase out

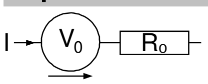
Package Y2			Ratings			
Symbol	**Definition**	**Conditions**	**min.**	**typ.**	**max.**	**Unit**
I_{RMS}	*RMS current*	per terminal			600	A
T_{VJ}	*virtual junction temperature*		-40		140	°C
T_{op}	*operation temperature*		-40		125	°C
T_{stg}	*storage temperature*		-40		125	°C
Weight				255		g
M_D	*mounting torque*		2.5		5	Nm
M_T	*terminal torque*		12		15	Nm
$d_{Spp/App}$	*creepage distance on surface | striking distance through air*	*terminal to terminal*	13.0			mm
$d_{Spb/Apb}$		*terminal to backside*	13.0			mm
V_{ISOL}	*isolation voltage*	t = 1 second; 50/60 Hz, RMS; $I_{ISOL} \le 1$ mA	3600			V
		t = 1 minute	3000			V



Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCD220-14io1	MCD220-14io1	Box	2	419281

Equivalent Circuits for Simulation

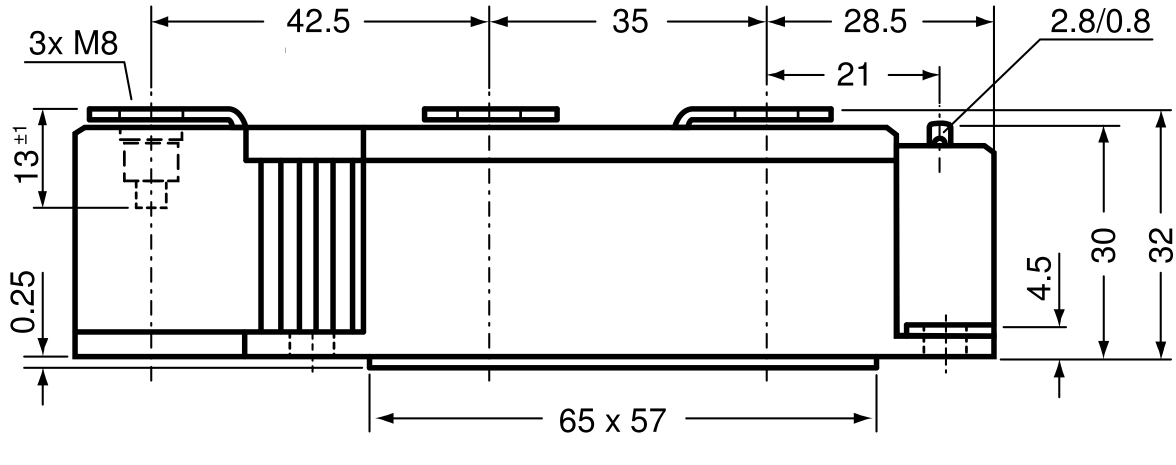
** on die level* $T_{VJ} = 140\,°C$

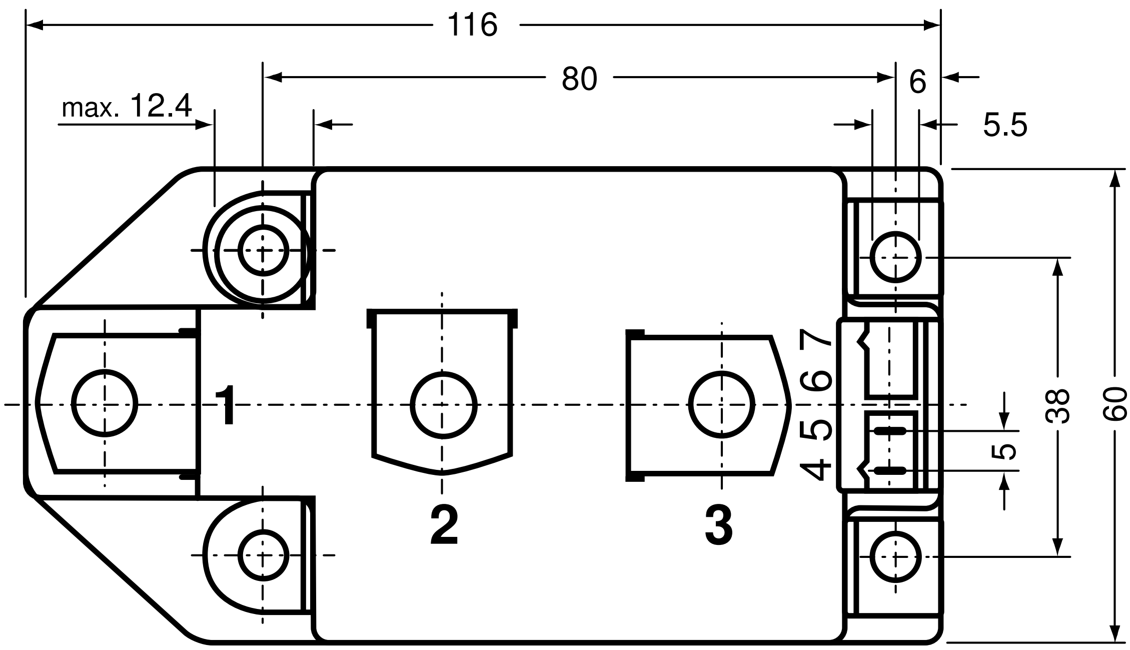


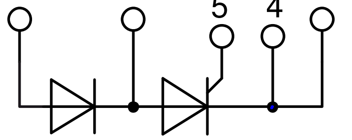
		Thyristor	
$V_{0\,max}$	*threshold voltage*	0.9	V
$R_{0\,max}$	*slope resistance **	0.5	mΩ

Phase out

Outlines Y2







Phase out

Thyristor

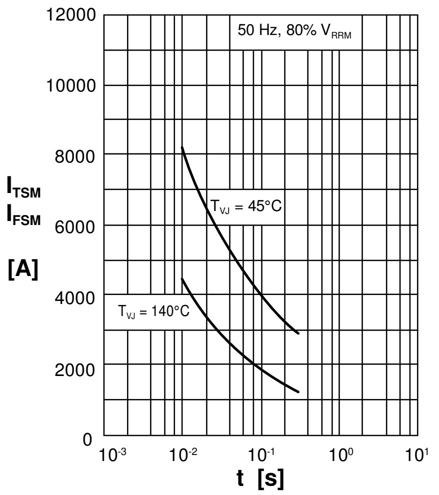


Fig. 1 Surge overload current
$I_{T(F)SM}$: crest value, t: duration

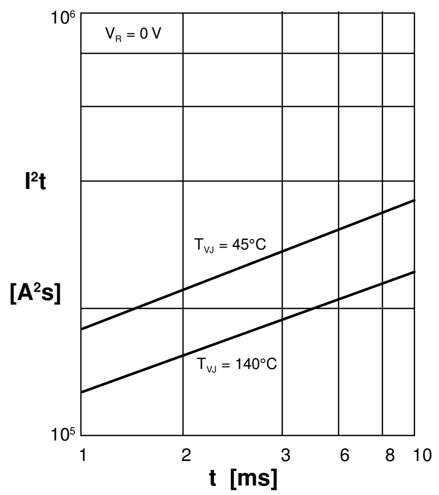


Fig. 2 I²t versus time (1-10 ms)

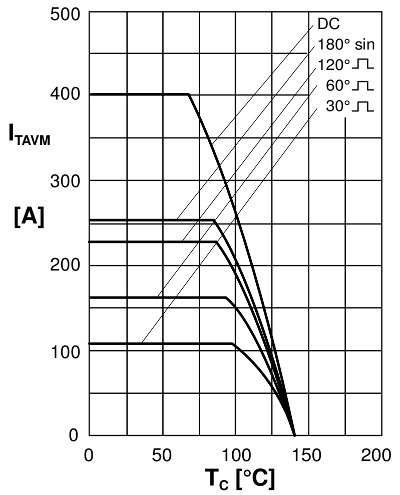


Fig. 3 Max. forward current at case temperature

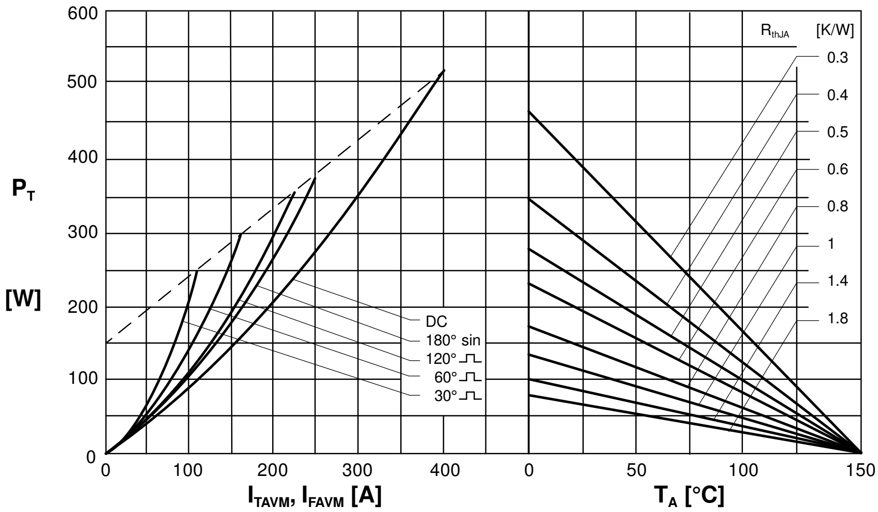


Fig. 4 Power dissipation versus onstate current and•
ambient temperature (per thyristor/diode)

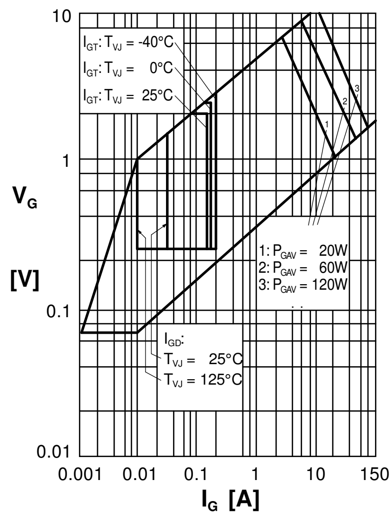


Fig. 5 Gate trigger characteristics

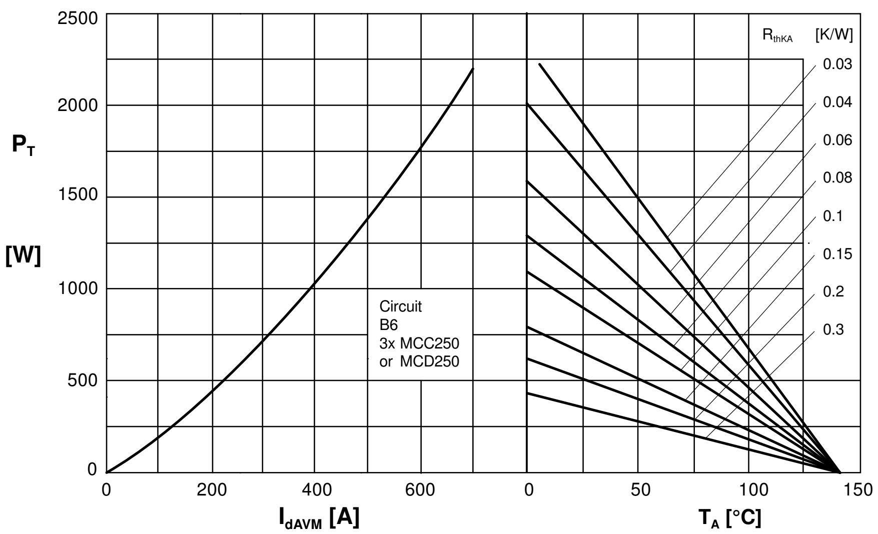


Fig. 6 Three phase rectifier bridge: Power dissipation versus
direct output current and ambient temperature

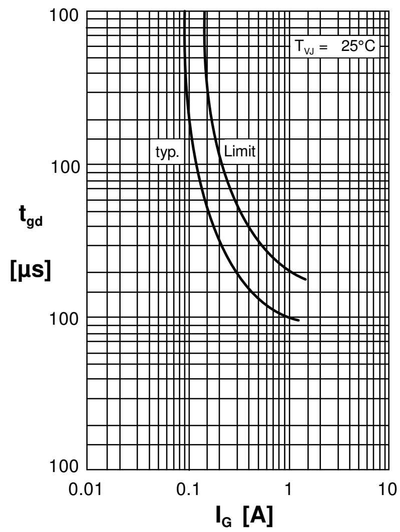


Fig. 7 Gate trigger delay time

Phase out

Rectifier

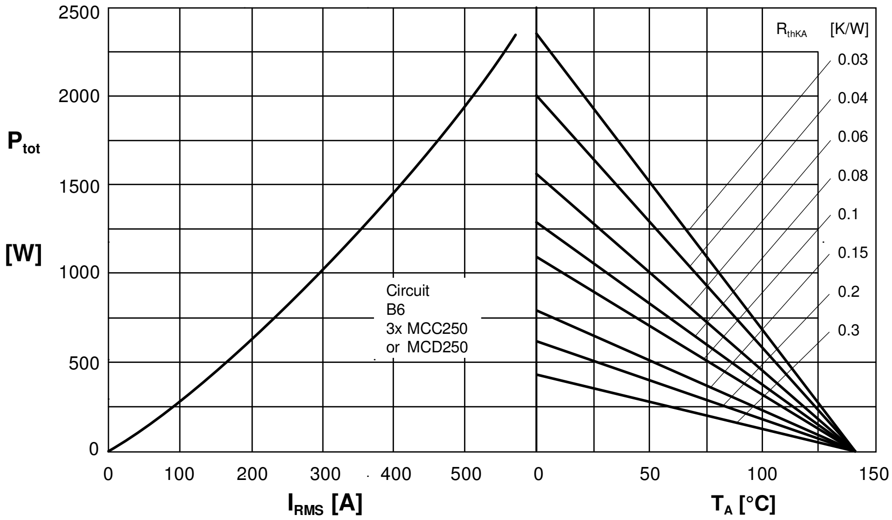


Fig. 7 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

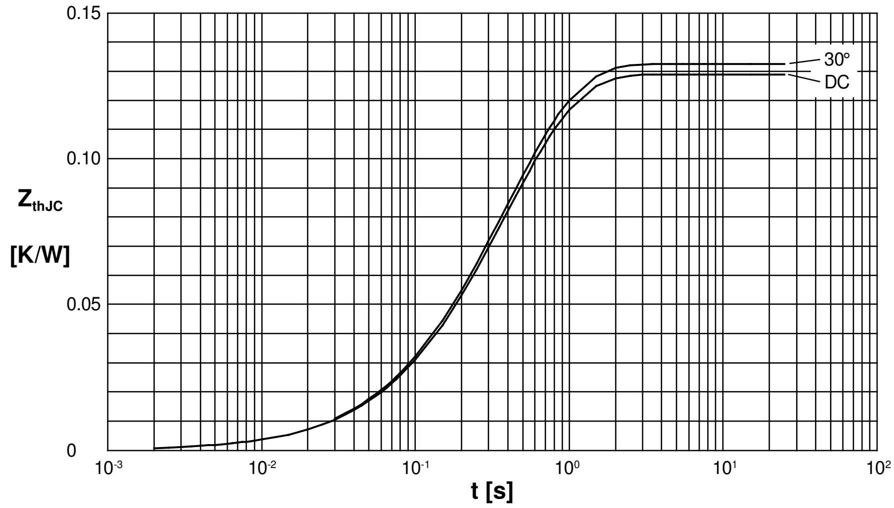


Fig. 8 Transient thermal impedance junction to case (per thyristor/diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} [K/W]
DC	0.139
180°C	0.141
120°C	0.142
60°C	0.142
30°C	0.143

Constants for Z_{thJC} calculation:

i	R_{thi} [K/W]	t_i [s]
1	0.0037	0.0099
2	0.0177	0.168
3	0.1175	0.456

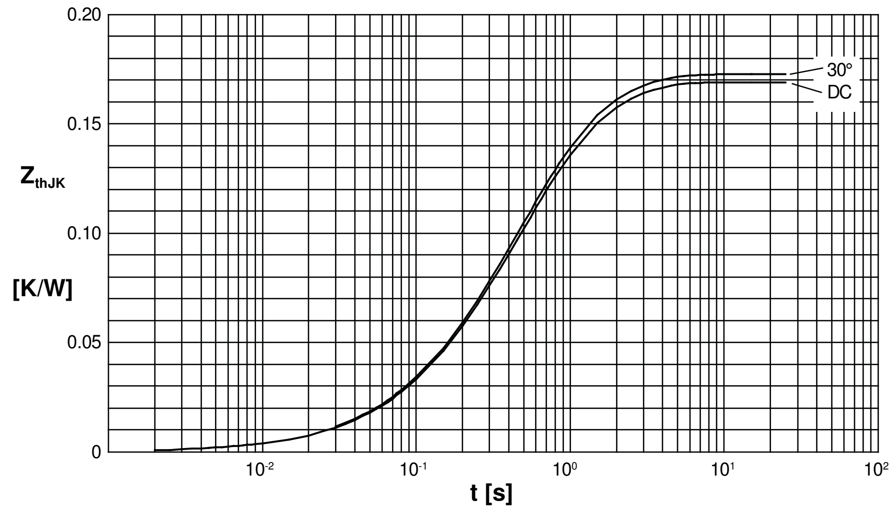


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor/diode)

R_{thJK} for various conduction angles d:

d	R_{thJK} [K/W]
DC	0.179
180°C	0.181
120°C	0.182
60°C	0.183
30°C	0.183

Constants for Z_{thJK} calculation:

i	R_{thi} [K/W]	t_i [s]
1	0.0033	0.0099
2	0.0159	0.168
3	0.1053	0.456
4	0.04	1.36